PBLS4005Y; PBLS4005V 40 V PNP BISS loadswitch Rev. 03 — 16 February 2009 Pr

Product data sheet

1. Product profile

1.1 General description

PNP low V_{CEsat} Breakthrough In Small Signal (BISS) transistor and NPN Resistor-Equipped Transistor (RET) in one package.

Table 1. **Product overview**

Type number	Package		
	NXP	JEITA	
PBLS4005Y	SOT363	SC-88	
PBLS4005V	SOT666	-	

1.2 Features

- Low V_{CEsat} (BISS) and resistor-equipped transistor in one package
- Low threshold voltage (<1 V) compared to MOSFET
- Low drive power required
- Space-saving solution
- Reduction of component count

1.3 Applications

- Supply line switches
- Battery charger switches
- High-side switches for LEDs, drivers and backlights
- Portable equipment

1.4 Quick reference data

Table 2. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
TR1; PNP lo	w V _{CEsat} transistor					
V_{CEO}	collector-emitter voltage	open base	-	-	-40	V
I _C	collector current		-	-	-500	mA
R _{CEsat}	collector-emitter saturation resistance	$I_{C} = -500 \text{ mA};$ $I_{B} = -50 \text{ mA}$	<u>[1]</u> _	440	700	mΩ
TR2; NPN re	esistor-equipped transistor					
V_{CEO}	collector-emitter voltage	open base	-	-	50	V



Table 2. Quick reference data ...continued

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I_{O}	output current		-	-	100	mA
R1	bias resistor 1 (input)		33	47	61	kΩ
R2/R1	bias resistor ratio		8.0	1	1.2	

^[1] Pulse test: $t_p \le 300 \ \mu s$; $\delta \le 0.02$.

2. Pinning information

Table 3. Pinning

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Pin	Description	Simplified outline	Graphic symbol
1	emitter TR1		
2	base TR1	6 5 4	6 5 4
3	output (collector) TR2		
4	GND (emitter) TR2		R1 R2
5	input (base) TR2		TR1
6	collector TR1	001aab555	
			1 2 3 sym036

3. Ordering information

Table 4. Ordering information

Type number	Package	Package		
	Name	Description	Version	
PBLS4005Y	SC-88	plastic surface-mounted package; 6 leads	SOT363	
PBLS4005V	-	plastic surface-mounted package; 6 leads	SOT666	

4. Marking

Table 5. Marking codes

Type number	Marking code ^[1]
PBLS4005Y	S5*
PBLS4005V	K5

[1] * = -: made in Hong Kong

* = p: made in Hong Kong

* = t: made in Malaysia

* = W: made in China

5. Limiting values

Table 6. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

		<u> </u>			
Symbol	Parameter	Conditions	Min	Max	Unit
TR1; PNP	low V _{CEsat} transistor				
V_{CBO}	collector-base voltage	open emitter	-	-40	V
V_{CEO}	collector-emitter voltage	open base	-	-40	V
V_{EBO}	emitter-base voltage	open collector	-	-6	V
I _C	collector current		-	-500	mA
I _{CM}	peak collector current	single pulse; $t_p \le 1$ ms	-	-1	Α
I _B	base current		-	-50	mA
I _{BM}	peak base current	single pulse; $t_p \le 1$ ms	-	-100	mA
P _{tot}	total power dissipation	$T_{amb} \le 25 ^{\circ}C$	[1] -	200	mW
TR2; NPN	resistor-equipped transis	tor			
V_{CBO}	collector-base voltage	open emitter	-	50	V
V_{CEO}	collector-emitter voltage	open base	-	50	V
V_{EBO}	emitter-base voltage	open collector	-	10	V
VI	input voltage				
	positive		-	+40	V
	negative		-	-10	V
Io	output current		-	100	mA
I _{CM}	peak collector current	single pulse; $t_p \le 1$ ms	-	100	mA
P _{tot}	total power dissipation	$T_{amb} \le 25 ^{\circ}C$	<u>[1]</u> _	200	mW
Per devic	е				
P _{tot}	total power dissipation	$T_{amb} \le 25 ^{\circ}C$	-	300	mW
Tj	junction temperature		-	150	°C
T _{amb}	ambient temperature		-65	+150	°C
T _{stg}	storage temperature		-65	+150	°C

^[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

6. Thermal characteristics

Table 7. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per device						
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air				
	SOT363		<u>[1]</u> _	-	416	K/W
	SOT666		[1][2]	-	416	K/W

^[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

^[2] Reflow soldering is the only recommended soldering method.

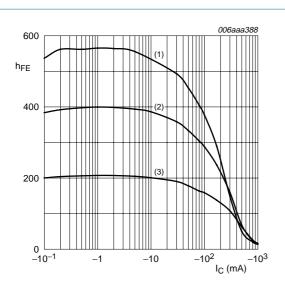
7. Characteristics

Table 8. Characteristics

T_{amb} = 25 °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
TR1; PNP	low V _{CEsat} transistor					
I _{CBO}	collector-base cut-off	$V_{CB} = -40 \text{ V}; I_E = 0 \text{ A}$	-	-	-100	nA
	current	$V_{CB} = -40 \text{ V}; I_E = 0 \text{ A};$ $T_j = 150 ^{\circ}\text{C}$	-	-	-50	μΑ
I _{EBO}	emitter-base cut-off current	$V_{EB} = -5 \text{ V}; I_C = 0 \text{ A}$	-	-	-100	nA
h _{FE}	DC current gain	$V_{CE} = -2 \text{ V}; I_{C} = -10 \text{ mA}$	200	-	-	
		$V_{CE} = -2 \text{ V}; I_{C} = -100 \text{ mA}$	[<u>1</u>] 150	-	-	
		$V_{CE} = -2 \text{ V}; I_{C} = -500 \text{ mA}$	<u>[1]</u> 40	-	-	
V _{CEsat}	collector-emitter	$I_C = -10 \text{ mA}; I_B = -0.5 \text{ mA}$	-	-	-50	mV
	saturation voltage	$I_C = -100 \text{ mA}; I_B = -5 \text{ mA}$	-	-	-130	mV
		$I_C = -200 \text{ mA}; I_B = -10 \text{ mA}$	-	-	-200	mV
		$I_C = -500 \text{ mA}; I_B = -50 \text{ mA}$	[1] -	-	-350	mV
R _{CEsat}	collector-emitter saturation resistance	$I_C = -500 \text{ mA}; I_B = -50 \text{ mA}$	[1] -	440	700	mΩ
V_{BEsat}	base-emitter saturation voltage	$I_C = -500 \text{ mA}; I_B = -50 \text{ mA}$	[1] _	-	-1.2	V
V_{BEon}	base-emitter turn-on voltage	$V_{CE} = -2 \text{ V}; I_{C} = -100 \text{ mA}$	<u>[1]</u> _	-	-1.1	V
f _T	transition frequency	$I_C = -100 \text{ mA}; V_{CE} = -5 \text{ V};$ f = 100 MHz	100	300	-	MHz
C _c	collector capacitance	$V_{CB} = -10 \text{ V}; I_E = i_e = 0 \text{ A};$ $f = 1 \text{ MHz}$	-	-	10	pF
TR2; NPN	resistor-equipped tran	sistor				
I _{CBO}	collector-base cut-off current	$V_{CB} = 50 \text{ V}; I_E = 0 \text{ A}$	-	-	100	nA
I _{CEO}	collector-emitter	$V_{CE} = 30 \text{ V}; I_{B} = 0 \text{ A}$	-	-	1	μΑ
	cut-off current	$V_{CE} = 30 \text{ V}; I_{B} = 0 \text{ A};$ $T_{j} = 150 ^{\circ}\text{C}$	-	-	50	μΑ
I _{EBO}	emitter-base cut-off current	$V_{EB} = 5 \text{ V}; I_{C} = 0 \text{ A}$	-	-	90	μΑ
h _{FE}	DC current gain	$V_{CE} = 5 \text{ V}; I_{C} = 5 \text{ mA}$	80	-	-	
V _{CEsat}	collector-emitter saturation voltage	$I_C = 10 \text{ mA}; I_B = 0.5 \text{ mA}$	-	-	150	mV
V _{I(off)}	off-state input voltage	$V_{CE} = 5 \text{ V}; I_{C} = 100 \mu\text{A}$	-	1.2	0.8	V
V _{I(on)}	on-state input voltage	$V_{CE} = 0.3 \text{ V}; I_{C} = 5 \text{ mA}$	3	1.6	-	V
R1	bias resistor 1 (input)		33	47	61	kΩ
R2/R1	bias resistor ratio		0.8	1	1.2	
C _c	collector capacitance	$V_{CB} = 10 \text{ V}; I_E = i_e = 0 \text{ A};$ f = 1 MHz	-	-	2.5	pF

^[1] Pulse test: $t_p \le 300 \ \mu s; \ \delta \le 0.02$.



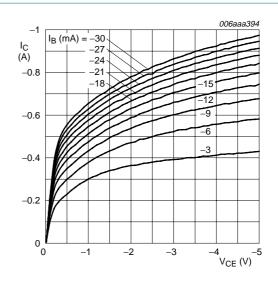
 $V_{CE} = -2 V$

(1)
$$T_{amb} = 100 \, ^{\circ}C$$

(2)
$$T_{amb} = 25 \,^{\circ}C$$

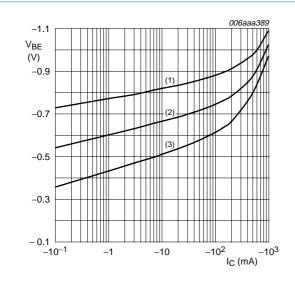
(3) $T_{amb} = -55 \, ^{\circ}C$

Fig 1. TR1 (PNP): DC current gain as a function of collector current; typical values



T_{amb} = 25 °C

Fig 2. TR1 (PNP): Collector current as a function of collector-emitter voltage; typical values



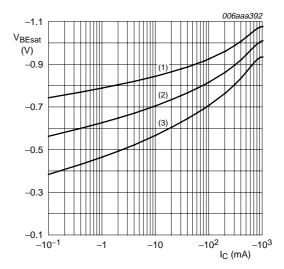
 $V_{CE} = -2 V$

(1)
$$T_{amb} = -55 \, ^{\circ}C$$

(2) $T_{amb} = 25 \, ^{\circ}C$

(3) $T_{amb} = 100 \, ^{\circ}C$

Fig 3. TR1 (PNP): Base-emitter voltage as a function of collector current; typical values



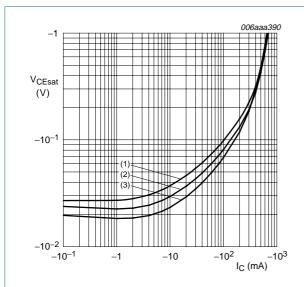
 $I_{\rm C}/I_{\rm B} = 20$

(1) $T_{amb} = -55 \, ^{\circ}C$

(2) $T_{amb} = 25 \, ^{\circ}C$

(3) $T_{amb} = 100 \, ^{\circ}C$

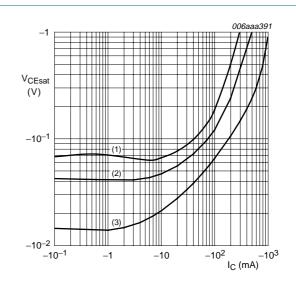
Fig 4. TR1 (PNP): Base-emitter saturation voltage as a function of collector current; typical values



$$I_{\rm C}/I_{\rm B} = 20$$

- (1) $T_{amb} = 100 \, ^{\circ}C$
- (2) $T_{amb} = 25 \, ^{\circ}C$
- (3) $T_{amb} = -55 \, ^{\circ}C$

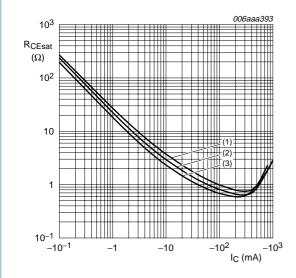
Fig 5. TR1 (PNP): Collector-emitter saturation voltage as a function of collector current; typical values



$$T_{amb} = 25 \, ^{\circ}C$$

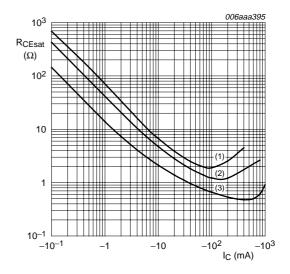
- (1) $I_C/I_B = 100$
- (2) $I_C/I_B = 50$
- (3) $I_C/I_B = 10$

Fig 6. TR1 (PNP): Collector-emitter saturation voltage as a function of collector current; typical values



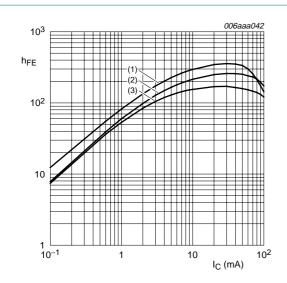
- $I_{\rm C}/I_{\rm B} = 20$
- (1) $T_{amb} = 100 \, ^{\circ}C$
- (2) $T_{amb} = 25 \, ^{\circ}C$
- (3) $T_{amb} = -55 \,^{\circ}C$

Fig 7. TR1 (PNP): Collector-emitter saturation resistance as a function of collector current; typical values



- (1) $I_C/I_B = 100$
- (2) $I_C/I_B = 50$
- (3) $I_C/I_B = 10$

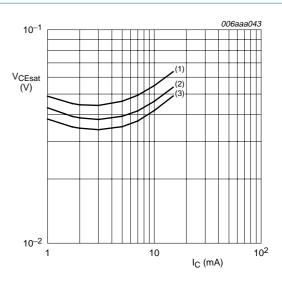
Fig 8. TR1 (PNP): Collector-emitter saturation resistance as a function of collector current; typical values



$$V_{CE} = 5 \text{ V}$$

- (1) $T_{amb} = 150 \, ^{\circ}C$
- (2) $T_{amb} = 25 \,^{\circ}C$
- (3) $T_{amb} = -40 \, ^{\circ}C$

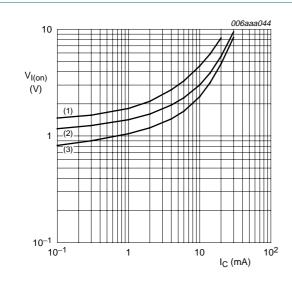
Fig 9. TR2 (NPN): DC current gain as a function of collector current; typical values



$$I_{\rm C}/I_{\rm B} = 20$$

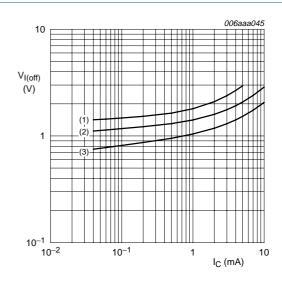
- (1) $T_{amb} = 100 \, ^{\circ}C$
- (2) $T_{amb} = 25 \, ^{\circ}C$
- (3) $T_{amb} = -40 \, ^{\circ}C$

Fig 10. TR2 (NPN): Collector-emitter saturation voltage as a function of collector current; typical values



- $V_{CE} = 0.3 V$
- (1) $T_{amb} = -40 \, ^{\circ}C$
- (2) $T_{amb} = 25 \, ^{\circ}C$
- (3) $T_{amb} = 100 \, ^{\circ}C$

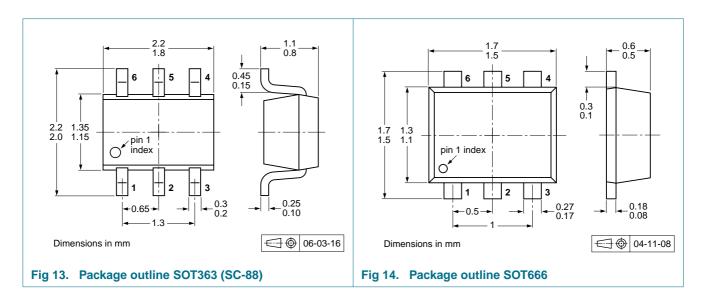
Fig 11. TR2 (NPN): On-state input voltage as a function of collector current; typical values



- $V_{CE} = 5 V$
- (1) $T_{amb} = -40 \, ^{\circ}C$
- (2) $T_{amb} = 25 \, ^{\circ}C$
- (3) $T_{amb} = 100 \, ^{\circ}C$

Fig 12. TR2 (NPN): Off-state input voltage as a function of collector current; typical values

8. Package outline



9. Packing information

Table 9. Packing methods

The indicated -xxx are the last three digits of the 12NC ordering code.[1]

Type number	e number Package Description		Packing quantity				
				3000	4000	8000	10000
PBLS4005Y	SOT363	4 mm pitch, 8 mm tape and reel; T1	[2]	-115	-	-	-135
		4 mm pitch, 8 mm tape and reel; T2	[3]	-125	-	-	-165
PBLS4005V	SOT666	2 mm pitch, 8 mm tape and reel		-	-	-315	-
		4 mm pitch, 8 mm tape and reel		-	-115	-	-

[1] For further information and the availability of packing methods, see Section 12.

[2] T1: normal taping

[3] T2: reverse taping

10. Revision history

Table 10. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes		
PBLS4005Y_PBLS4005V_3	20090216	Product data sheet	-	PBLS4005Y_PBLS4005V_2		
Modifications:		 The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors. 				
	 Legal texts have been adapted to the new company name where appropriate. 					
	• Figure 5: y-ax	kis value unit amended				
	• Figure 6: y-ax	kis value unit amended				
	 Section 11 "L 	egal information": updat	ed			
PBLS4005Y_PBLS4005V_2	20050713	Product data sheet	-	PBLS4005Y_PBLS4005V_1		
PBLS4005Y_PBLS4005V_1	20041206	Product data sheet	-	-		

11. Legal information

11.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
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12. Contact information

For more information, please visit: http://www.nxp.com

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